

11-29-1999

Attorney Docket No.: 018150.0173

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To the Honorable Commissioner of Patent

101210637

d original document(s) or copy(ies) thereof.

1. Name of Conveying Party(ies):

Ming-Wei LEE

Hung-Chang HUANG

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and Address of Party(ies) receiving an interest (assignee(s)):

Name: Mitac International Corp.

Address: No. 1, R&D 2nd Road
Science-Based Industrial Park

Country: Hsinchu City, TAIWAN

Additional name(s) and address(es) attached?

☐ Yes☒ No

3. Nature of Conveyance:

☒ Assignment☐

Merger

☐

Change of Name

☐ Verified Translation☐

Security Agreement

☐

Other: _____

Execution Date: **September 7, 1999**

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date(s) of the application is: _____

A. Patent Application No(s):**09/399,139**B. Patent No(s):

Others on additional sheet(s) attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

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6. Total number of applications and patents involved:

Application(s): 1
+ Patent(s): 0
= Total: 17. Total Fee (37 C.F.R. § 3.41) \$ **40.00**☒ Enclosed☐ Authorized to be charged to Deposit Account8. Deposit Account No.: **02-0375**

(Duplicate copy of this sheet attached)

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9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James B. Arpin

Name of Person Signing

Signature

11/18/99

Date

Total number of pages including cover sheet, attachments, and document:

2

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PATENT
REEL: 010396 FRAME: 0792

ASSIGNMENT DEED

This assignment agreement is applicable to an invention entitled (Invention Title) MODULAR COMPUTER ASSEMBLY HAVING SYSTEM CIRCUIT MODULE AND PERIPHERAL CIRCUIT MODULE

The PATENT RIGHTS referred to in this agreement are:

- (check one) ☒ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.
☐ U.S. patent application Serial No. _____, filed _____
☐ U.S. patent No. _____, issued _____

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

- (check one) ☒ U.S. patent rights only.
☐ worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. patent application identified above.

The ASSIGNOR(S) referred to in this agreement is (or are):

(Full name of sole or first inventor) Ming-Wei LEE

(Address) 2F, No.6, Lane 75, Yun-Ho St., Taipei City, Taiwan

(Full name of second joint inventor, if any) Hung-Chang HUANG

(Address) 4F, No. 84, Sec. 3, Cheng-Kung Rd., Nei-Hu Dist., Taipei City, Taiwan

(Full name of third joint inventor, if any) _____

(Address) _____

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) MITAC INTERNATIONAL CORP.

(Address of assignee) No. 1, R & D 2nd Rd., Science-Based Industrial Park, Hsinchu City, Taiwan

The ASSIGNEE is:

- (check one) ☐ An Individual.
☐ A Partnership.
☒ A Corporation of Taiwan (state or country)
☐ _____

The ASSIGNOR(S), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to the ASSIGNEE; its successors and assigns:

- the full and exclusive right to the invention;
- the entire right, title and interest in and to the PATENT RIGHTS; and
- the right to claim priority under 35 USC 119, based on any earlier foreign applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

LEE MING-WEI

(Signature of sole or first inventor)

Sep. 7, 1999

(Date)

Huang Hung-Chang

(Signature of second inventor, if any)

Sep. 7, 1999

(Date)

(Signature of third inventor, if any)

(Date)